

Descriptions

This is N-Ch SiC Power MOSFET in a TO-247 Plastic Package.

Features

- VDS=1700V
- ID=5A (Tc=25°C)
- RDS=710mΩ (VGS=15V, TJ=25°C)
- Low On-Resistance with High Blocking Voltage
- Low Capacitance
- Halogen Free, Rohs Compliant

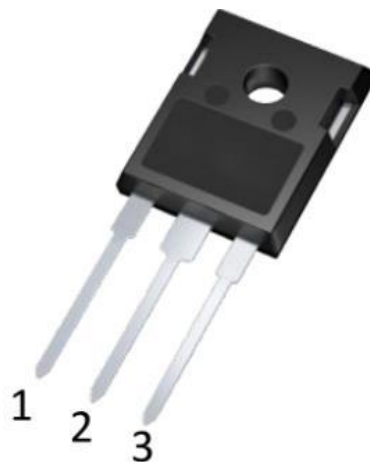
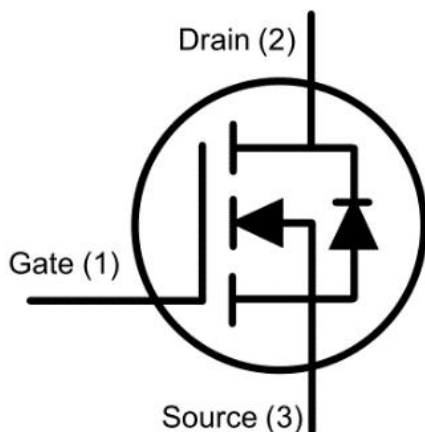
Applications

- Switch Mode Power Supplies (SMPS)
- Auxiliary power supplies
- High-voltage capacitive loads

Benefits

- High Frequency Operation
- Enabling Higher Switching Frequency
- Increased Power Density
- Reduction of Heat Sink Requirements

Schematic & PIN Configuration



Maximum Rated Valued of MOSFET

| | | | | |
|--------------------------------|-------------|-------------------------------------|------------|-------------|
| Drain-source voltage | V_{DSS} | | 1700 | V |
| Recommend Gate-Source Voltage | V_{GSop} | | -5/12...15 | V |
| Gate-Source Voltage | V_{GSmax} | AC(f > 1KHz) | -10/25 | V |
| Continuous drain current | I_D | $V_{GS}=15V, T_C=100^{\circ}C$ | 3.5 | A |
| | | $V_{GS}=15V, T_C=25^{\circ}C$ | 5 | A |
| Pulsed drain current | I_{DM} | t_{Pulse} limited by T_{jmax} | 12 | A |
| Maximum power dissipation | P_{tot} | $T_C=25^{\circ}C, T_J=150^{\circ}C$ | 70 | W |
| Operating Junction Temperature | T_J | | -55~150 | $^{\circ}C$ |
| Storage Temperature | T_{stg} | | -55~150 | $^{\circ}C$ |

Thermal Characteristic

| | | | | |
|---|-----------------|--|------|---------------|
| Thermal resistance, junction-to-case | $R_{\theta JC}$ | | 1.78 | $^{\circ}C/W$ |
| Thermal resistance, junction-to-ambient | $R_{\theta JA}$ | | 62.5 | $^{\circ}C/W$ |

Electrical Characteristics of MOSFET

| | | | | | | | |
|----------------------------------|---------------------|---|----------|---------|------|------|----|
| Drain-Source breakdown voltage | V(BR) _{DS} | ID=250uA, VGS=0V | TJ=25°C | 1700 | - | - | V |
| Gate threshold voltage | VGS(th) | ID=5mA, VDS=VGS | TJ=25°C | 2.0 | 2.9 | 4.0 | V |
| | | | TJ=150°C | - | 2.0 | - | |
| Zero gate voltage drain current | IDSS | VDS=1700V, VGS=0V | TJ=25°C | - | - | 100 | uA |
| Gate-Source leakage current | IGSSF | VDS=0V, VGS=20V | TJ=25°C | - | - | 200 | nA |
| | IGSSR | VDS=0V, VGS=-4V | TJ=25°C | - | - | -200 | nA |
| Drain-Source On-State resistance | RDS(ON) | VGS=15V, ID=2A | TJ=25°C | - | 710 | 850 | mΩ |
| | | | TJ=150°C | - | 1010 | - | mΩ |
| | | VGS=12V, ID=2A | TJ=25°C | - | 1040 | 1200 | mΩ |
| | | | TJ=150°C | - | 1230 | - | mΩ |
| Transconductance | gfs | VDS=20V, ID=2A | TJ=25°C | - | 7.3 | - | S |
| Internal gate resistance | RGint | f=1MHz, VAC=25mV | TJ=25°C | - | 20 | - | Ω |
| Input capacitance | Ciss | f=1MHz, VDS=1000V, VGS=0V, VAC=25mV | TJ=25°C | - | 380 | - | pF |
| Output capacitance | Coss | | TJ=25°C | - | 14 | - | pF |
| Reverse transfer capacitance | Crss | | TJ=25°C | - | 3.2 | - | pF |
| Gate to source charge | QGS | | VDS=800V | TJ=25°C | - | 4.8 | - |
| Gate to drain charge | QGD | IDS=2A | TJ=25°C | - | 5.6 | - | nC |
| Total gate charge | QG | VGS= -5V/20V | TJ=25°C | - | 13 | - | nC |
| Turn-on delay time | td on | VDS=1200V, IDS=2A, RG-ext=2.5Ω, VGS=-5V/20V, | TJ=25°C | - | 6 | - | ns |
| Rise time | tr | | TJ=25°C | - | 9.5 | - | ns |
| Turn-off delay time | td off | | TJ=25°C | - | 14 | - | ns |
| Fall time | tf | | TJ=25°C | - | 23 | - | ns |
| Turn-on energy loss per pulse | Eon | | TJ=25°C | - | 37 | - | uJ |
| Turn-off energy loss per pulse | Eoff | | TJ=25°C | - | 15 | - | uJ |

Characteristics of Body Diode

| | | | | | | | |
|----------------------------------|-----|-------------------|----------|---|-----|---|----|
| Forward voltage | VSD | ISD=1A, VGS=-4V | TJ=25°C | - | 3.5 | - | V |
| Continuous diode forward current | IS | | TJ=25°C | - | - | 4 | A |
| Peak reverse recovery current | IRM | VR=1200V, ISD=2A, | TJ=150°C | - | 3.5 | - | A |
| Reverse recovery time | trr | VGS=-5V | TJ=150°C | - | 22 | - | ns |
| Recovery charge | Qrr | -di/dt=1200A/us | TJ=150°C | - | 31 | - | nC |

Typical Characteristics

Fig.1 Typical Forward Output Characteristics at $T_J=25^\circ\text{C}$

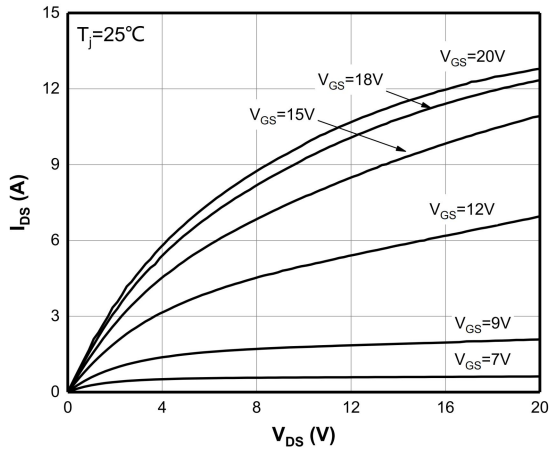


Fig.2 Typical Forward Output Characteristics at $T_J=150^\circ\text{C}$

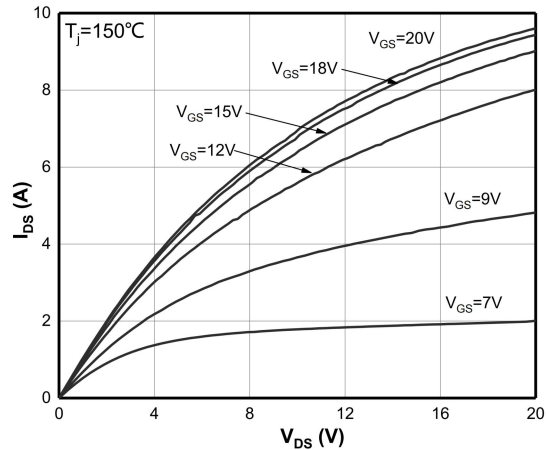


Fig.3 Transfer Characteristics for Various Temperature

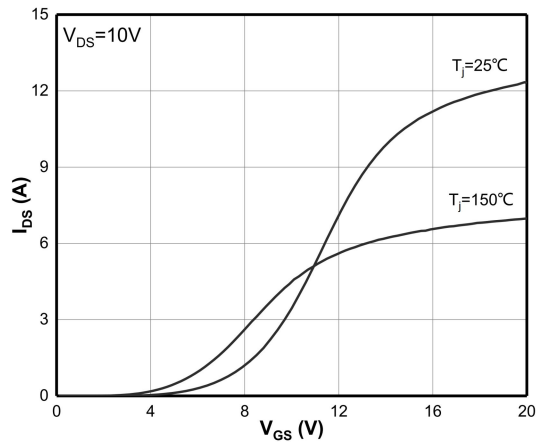


Fig.4 Threshold Voltage for Various Temperature

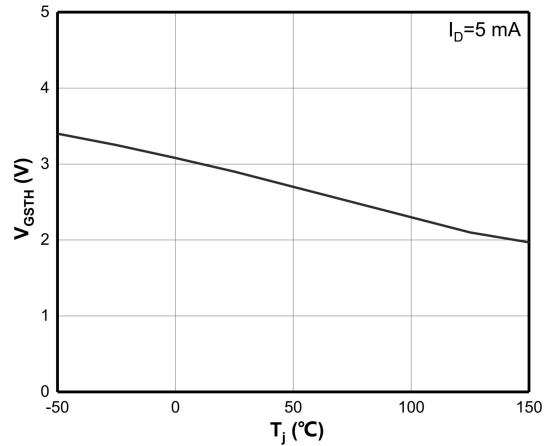


Fig.5 Normalized On-Resistance vs. Temperature for Various Gate Voltage

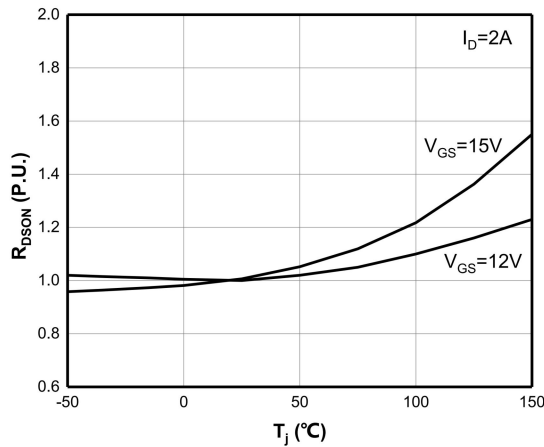
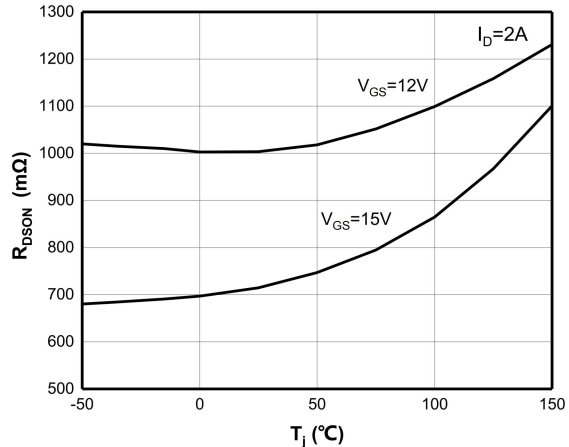


Fig.6 On-Resistance vs. Temperature for Various Gate Voltage



Typical Characteristics

Fig.7 Breakdown Voltage vs. Temperature

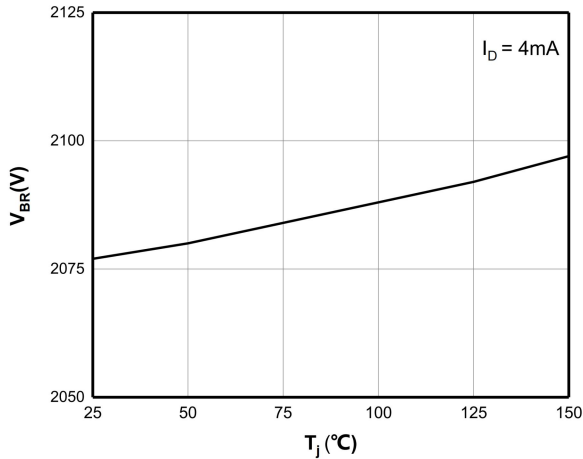


Fig.9 Capacitance vs. Drain-Source Voltage

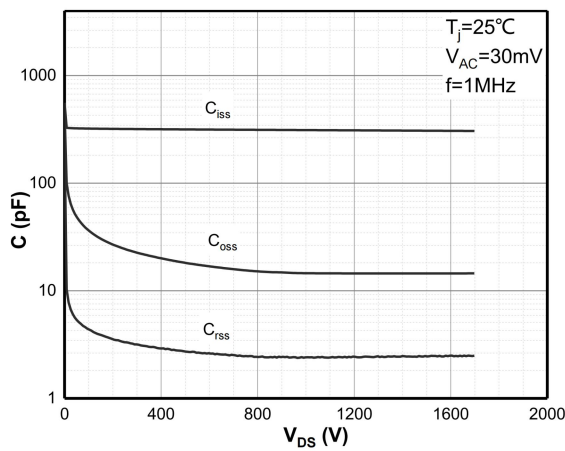


Fig.11 Continuous Drain Current Derating vs. Case Temperature

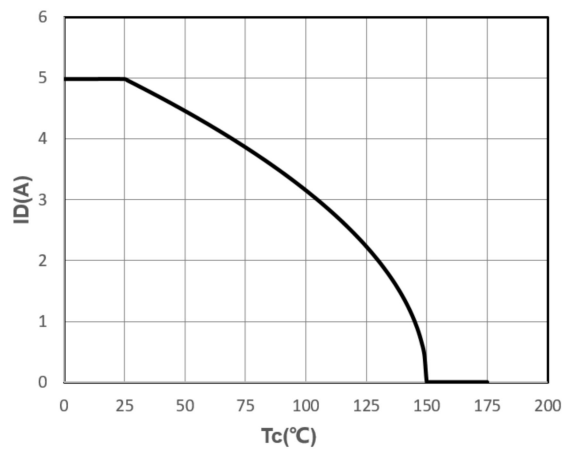


Fig.8 Body Diode Characteristics

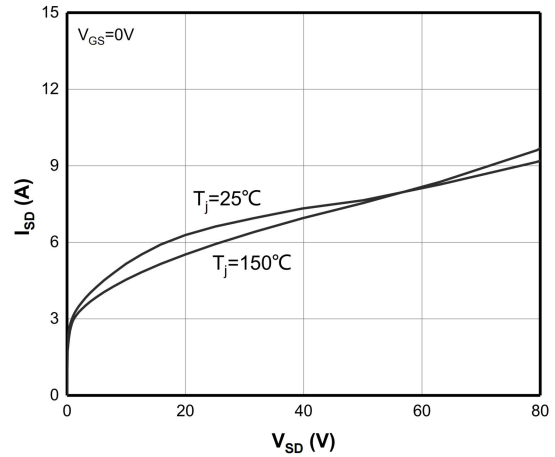


Fig.10 Gate Charge Characteristics

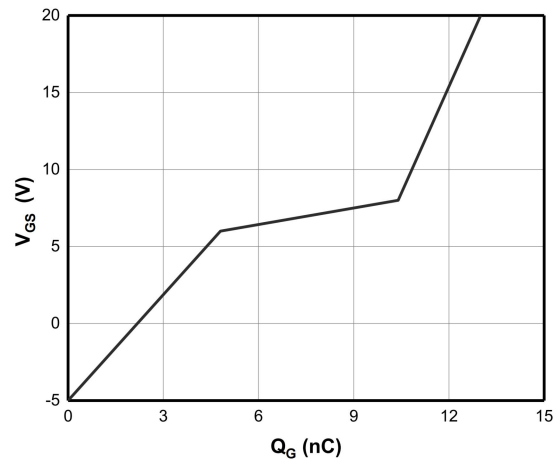
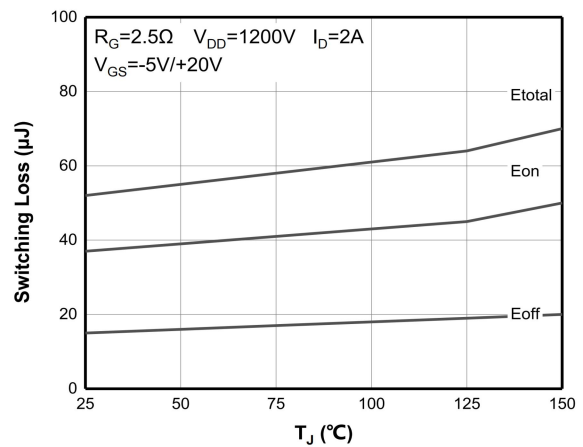


Fig.12 Clamped inductive switching energy vs. temperature



Typical Characteristics

Fig.13 Clamped Inductive Switching Energy vs. External Gate Resistance

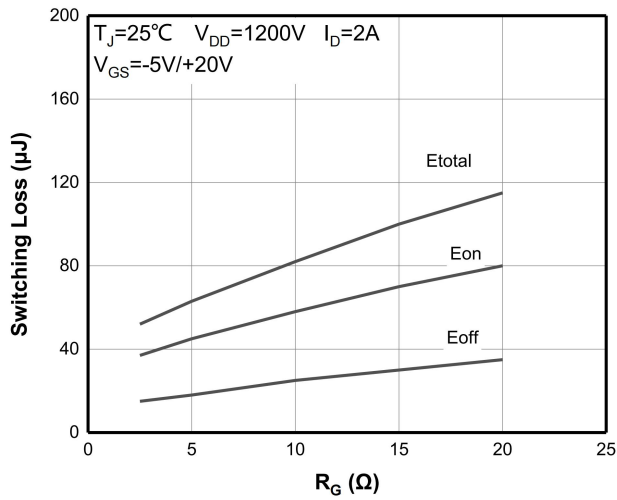


Fig.14 Safe Operating Area

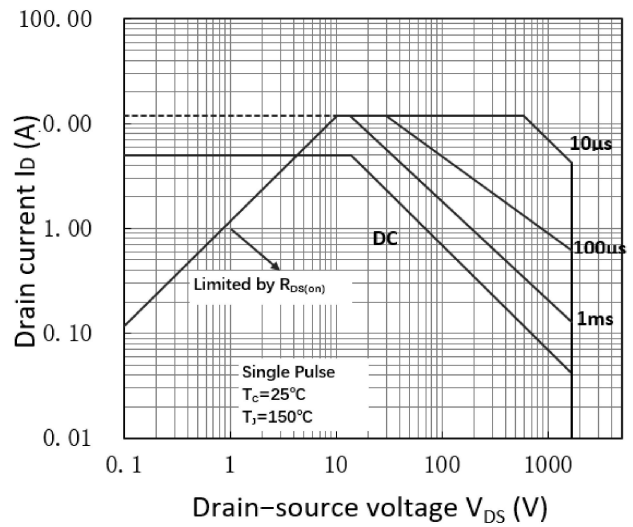
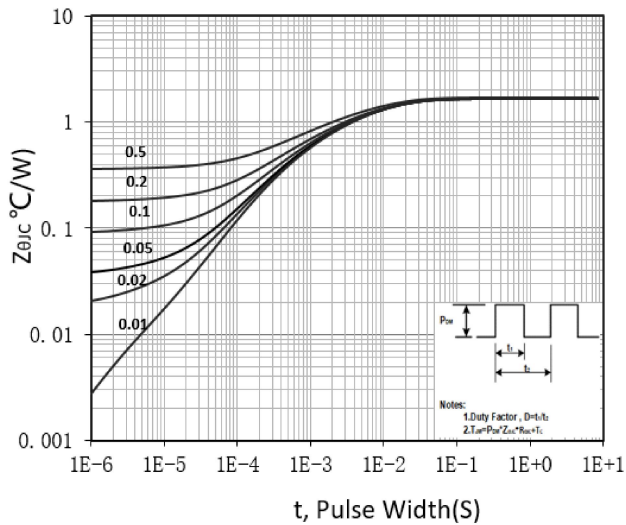


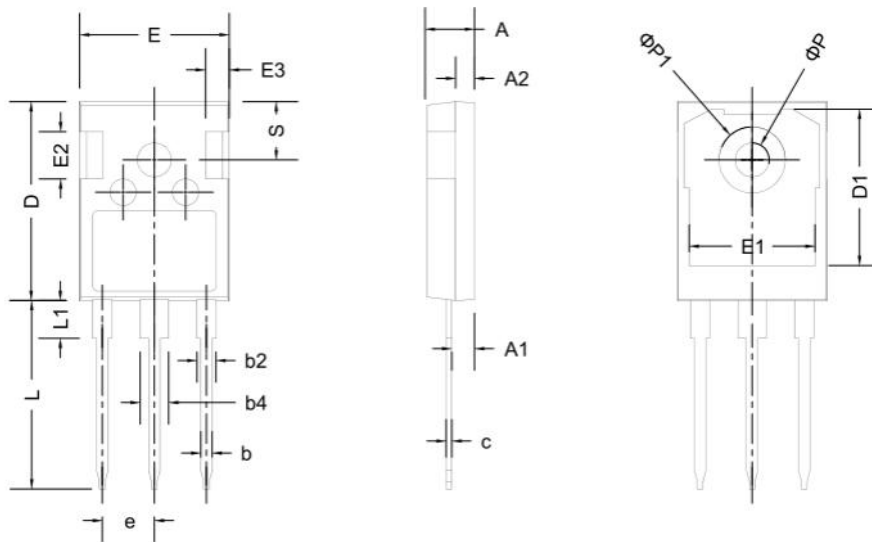
Fig.15 Transient Thermal Impedance (Junction – Case)



Ordering Information

| Part | Package | Marking | Packing method |
|----------------|---------|-----------|----------------|
| CTCM01KJ170T2C | TO-247 | 1KJ170T2C | Tube |

Package Information



| SYMBOL | mm | | |
|--------|----------|-------|-------|
| | MIN | NOM | MAX |
| A | 4.80 | 5.00 | 5.20 |
| A1 | 2.21 | 2.41 | 2.59 |
| A2 | 1.85 | 2.00 | 2.15 |
| b | 1.11 | 1.21 | 1.36 |
| b2 | 1.91 | 2.01 | 2.21 |
| b4 | 2.91 | 3.01 | 3.21 |
| c | 0.51 | 0.61 | 0.75 |
| D | 20.80 | 21.00 | 21.30 |
| D1 | 16.25 | 16.55 | 16.85 |
| E | 15.50 | 15.80 | 16.10 |
| E1 | 13.00 | 13.30 | 13.60 |
| E2 | 4.80 | 5.00 | 5.20 |
| E3 | 2.30 | 2.50 | 2.70 |
| e | 5.44 BSC | | |
| L | 19.62 | 19.92 | 20.22 |
| L1 | - | - | 4.30 |
| φ P | 3.40 | 3.60 | 3.80 |
| φ P1 | - | - | 7.30 |
| S | 6.16 BSC | | |